

Features

- Advanced Trench Cell Design
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free. "Green" Device ⁽¹⁾
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

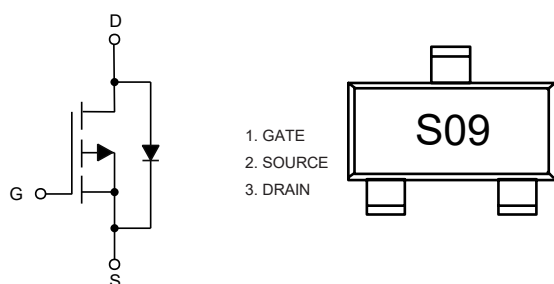
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 103.1°C/W Junction to Ambient (Steady-State) ⁽²⁾

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DS}	-60	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _A =25°C	I _D	-1.6	A
	T _A =100°C		-1.0	
Pulsed Drain Current ⁽³⁾		I _{DM}	-8.0	A
Total Power Dissipation ⁽⁴⁾		P _D	1.2	W

Note:

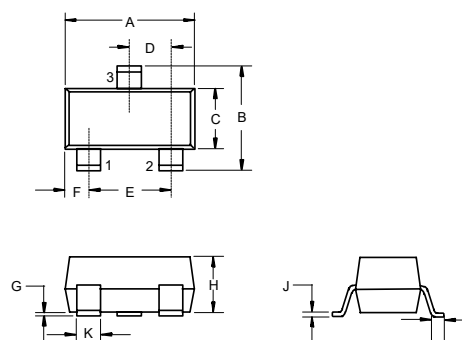
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The Power dissipation P_{DSM} is based on $R_{\theta JA} \leq 10\text{s}$ and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction to ambient thermal resistance.

Internal Structure and Marking Code



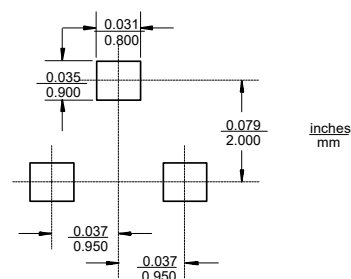
P-CHANNEL MOSFET

SOT-23



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.110	0.120	2.80	3.04	
B	0.090	0.104	2.30	2.64	
C	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.004	0.01	0.10	
H	0.035	0.040	0.90	1.02	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout



Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250μA	-60			V
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V			-1	μA
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1		-2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-1.5A		120	160	mΩ
		V _{GS} =-4.5V, I _D =-1A		160	240	
Gate Resistance	R _g	F=1MHz, Open drain		5		Ω
Diode Characteristics						
Continuous Body Diode Current	I _S				-1.6	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-1.5A			-1.2	V
Reverse Recovery Time	t _{rr}	I _F =-1.5A, dI _F /dt=100A/μs		18.1		ns
Reverse Recovery Charge	Q _{rr}			13		nC
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =-30V,V _{GS} =0V,f=1MHz		429		pF
Output Capacitance	C _{oss}			34		
Reverse Transfer Capacitance	C _{rss}			27.5		
Total Gate Charge	Q _g	V _{DS} =-30V,V _{GS} =-10V,I _D =-1.5A		10.4		nC
Gate-Source Charge	Q _{gs}			1.4		
Gate-Drain Charge	Q _{gd}			2.6		
Turn-On Delay Time	t _{d(on)}	V _{DD} =-30V, V _{GS} =-10V, R _{GEN} =3Ω, I _{DS} =-1.5A		7		ns
Turn-On Rise Time	t _r			4		
Turn-Off Delay Time	t _{d(off)}			17		
Turn-Off Fall Time	t _f			5.9		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

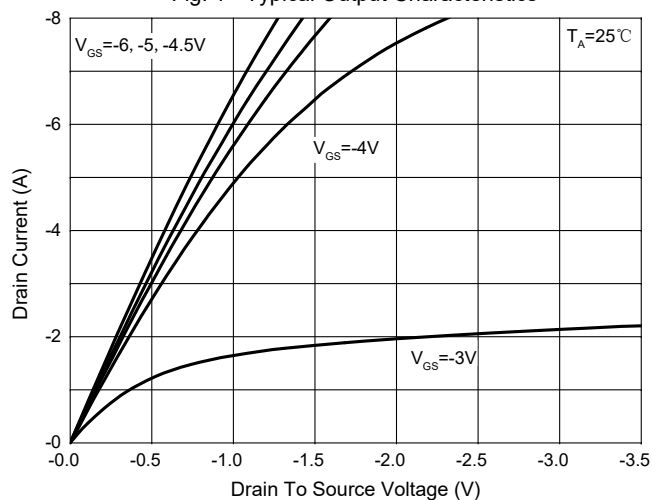


Fig. 2 - Transfer Characteristics

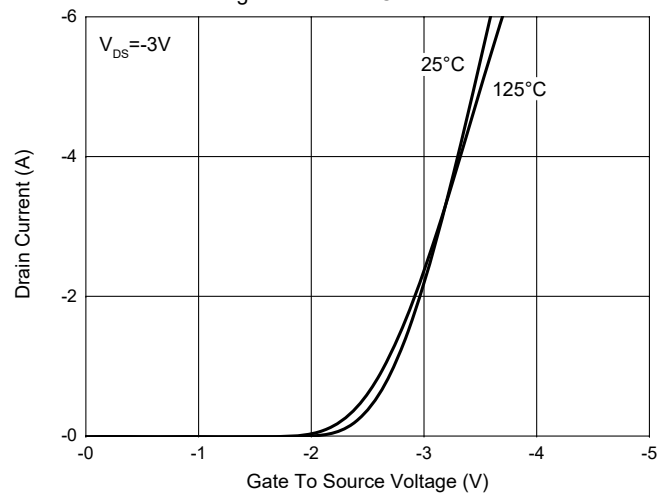


Fig. 3 - $R_{DS(ON)} - I_D$

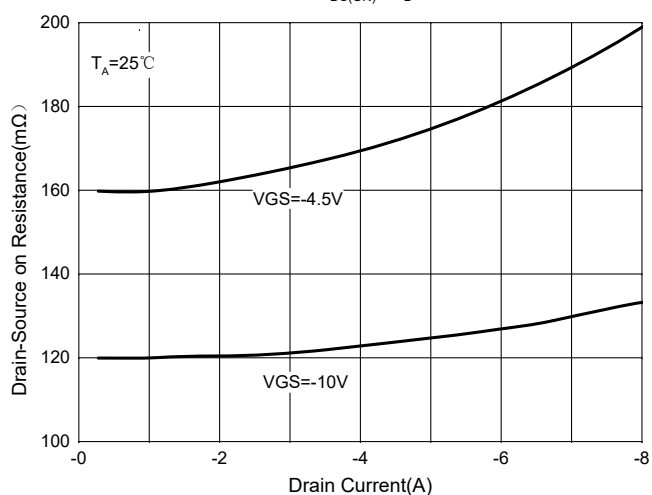


Fig. 4 - $R_{DS(ON)} - V_{GS}$

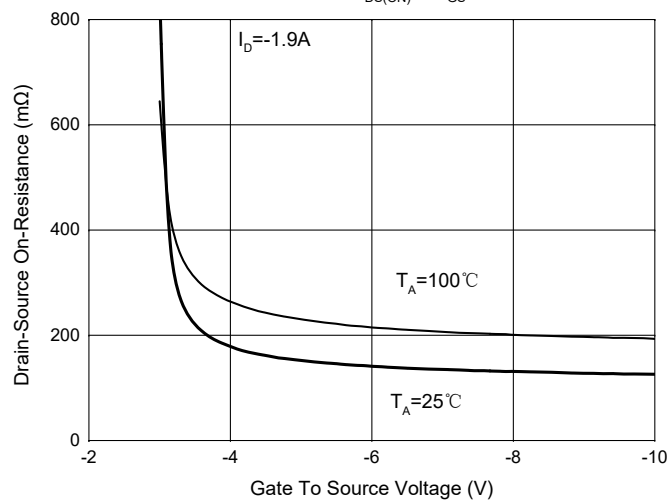


Fig. 5 - $I_S - V_{SD}$

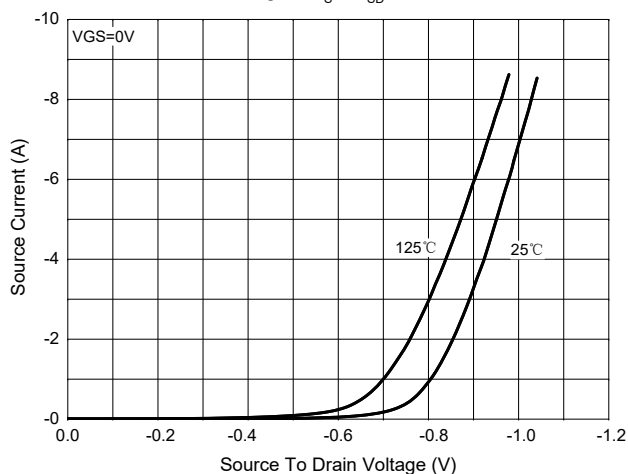
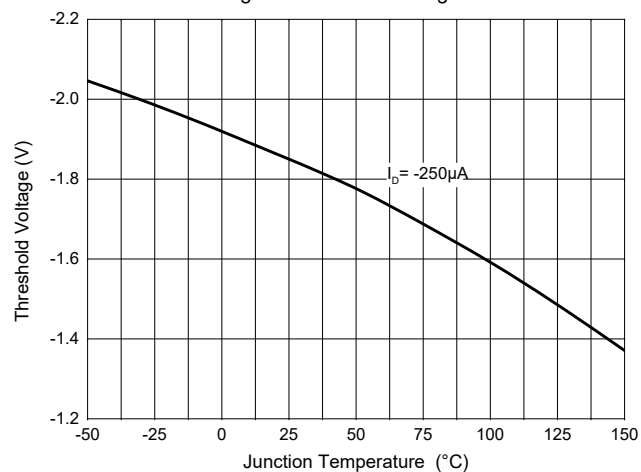


Fig. 6 - Threshold Voltage



Curve Characteristics

Fig. 7 - GateCharge

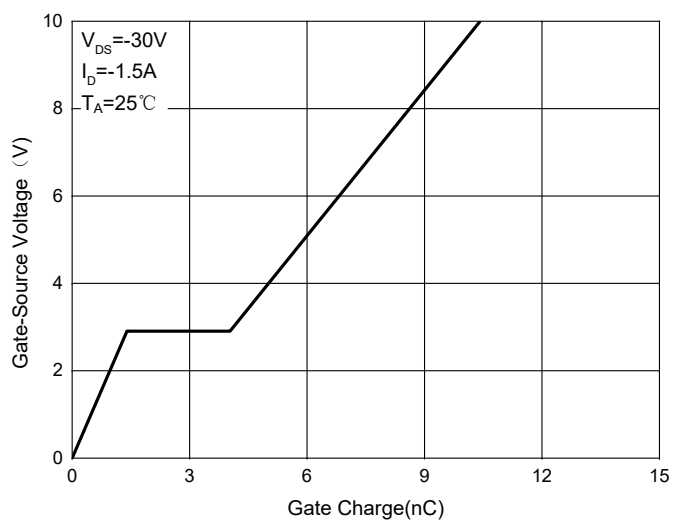


Fig.8-NormalizedOnResistanceCharacteristics

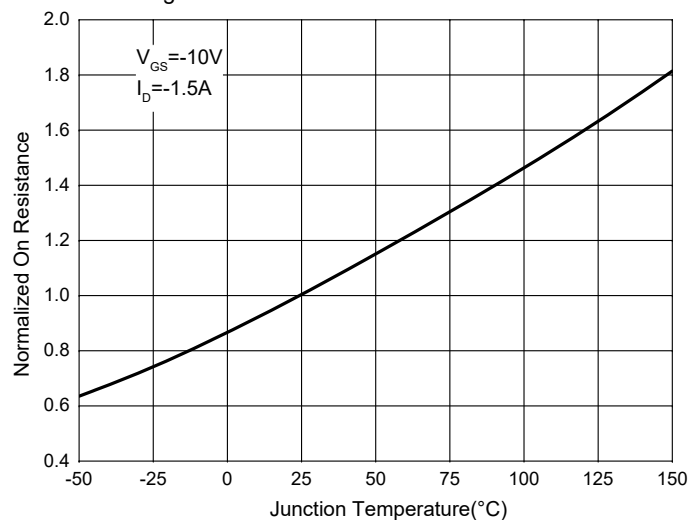


Fig. 9 - Capacitance Characteristics

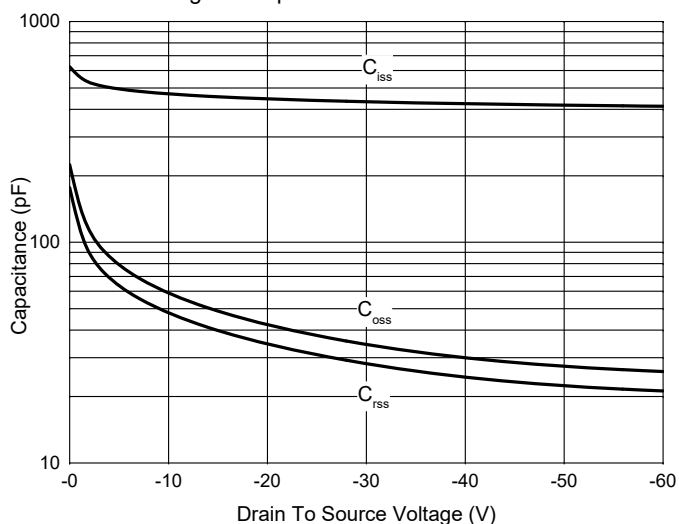


Fig. 10 - Current dissipation

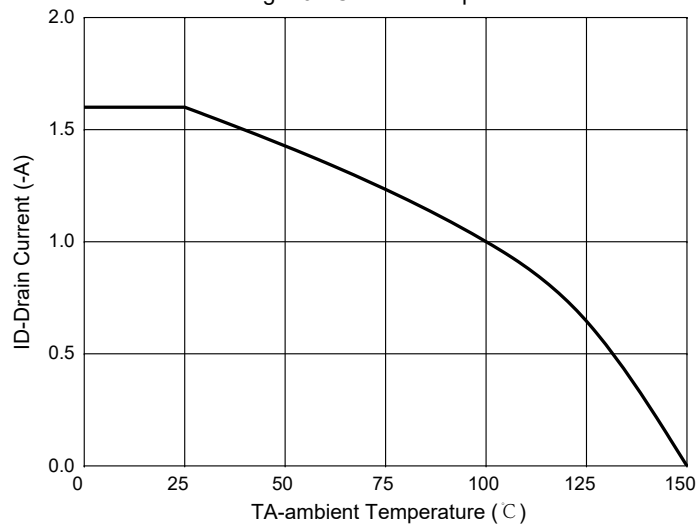
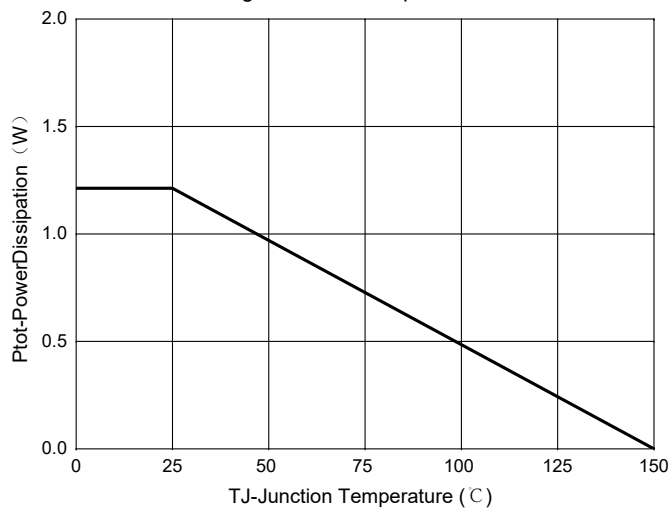


Fig.11-PowerDissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

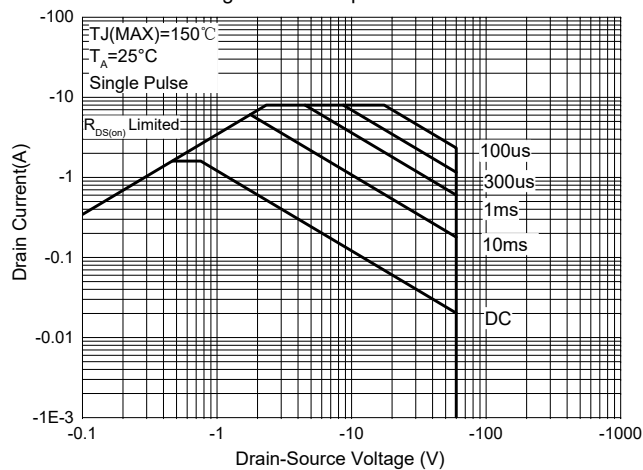
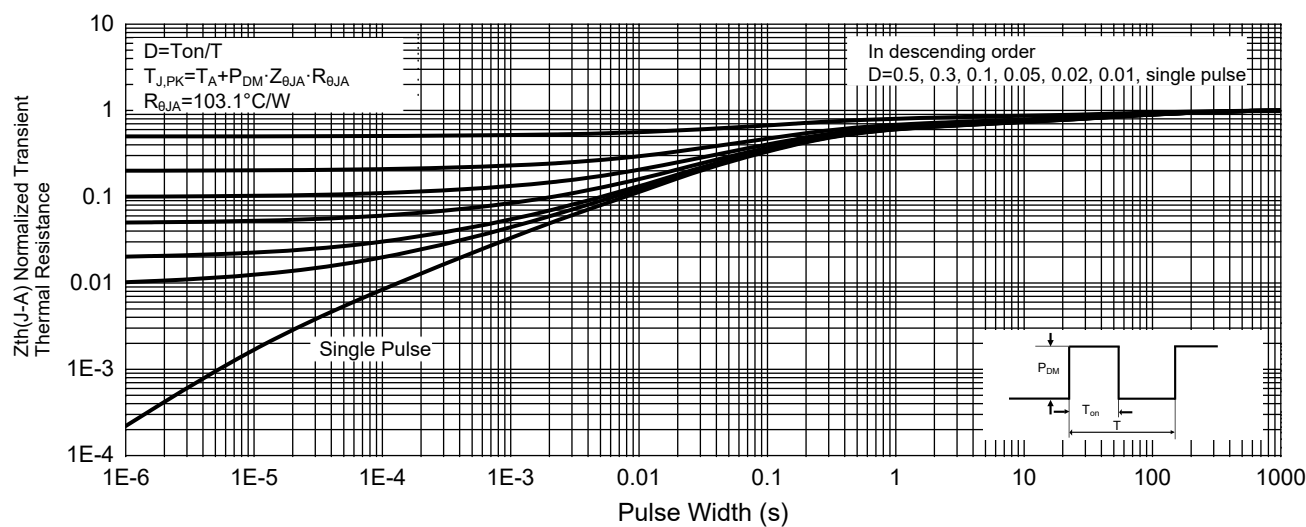


Fig. 13 -Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel
Part Number-13P	Tape&Reel: 10Kpcs/Reel

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